



A Product Line of Diodes Incorporated



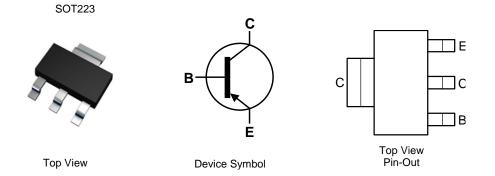
150V PNP MEDIUM POWER TRANSISTOR IN SOT223

Features

- BV_{CEO} > -150V
- I_C = -1A Continuous Current
- I_{CM} = -2A Peak Pulse Current
- Complementary NPN Type: FZT655
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: SOT223
- Case Material: Molded Plastic. "Green" Molding Compound; UL Flammability Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads; Solderable per MIL-STD-202, Method 208
- Weight: 0.112 grams (Approximate)



Ordering Information (Note 4)

Product	Compliance	Marking	Reel Size (inches)	Tape Width (mm)	Quantity per Reel
FZT755TA	AEC-Q101	FZT755	7	12	1,000

Notes: 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.

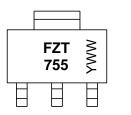
2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-Free, "Green" and Lead-Free.

3. Halogen- and Antimony-Free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information





FZT 755 = Product Type Marking Code YWW = Date Code Marking Y or \overline{Y} = Last Digit of Year (ex: 5= 2015) WW or \overline{WW} = Week Code (01~53)





Absolute Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V _{CBO}	-150	V
Collector-Emitter Voltage	V _{CEO}	-150	V
Emitter-Base Voltage	V _{EBO}	-7	V
Continuous Collector Current	I _C	-1	A
Peak Pulse Current	I _{CM}	-2	А

Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
	(Note 5)		3.0	
Power Dissipation	(Note 6)		2.0	w
	(Note 7)	PD	1.6	vv
	(Note 8)		1.2	
	(Note 5)		41.7	
Thermal Resistance, Junction to Ambient	(Note 6)		62.5	°C/W
mermai Resistance, Junction to Ambient	(Note 7)	R _{0JA}	78.1	C/VV
	(Note 8)		104	
Thermal Resistance, Junction to Leads	(Note 9)	R _{θJL}	12.9	°C/W
Operating and Storage Temperature Range	T _{J,} T _{STG}	-55 to +150	°C	

ESD Ratings (Note 10)

Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge - Human Body Model	ESD HBM	4,000	V	ЗA
Electrostatic Discharge - Machine Model	ESD MM	400	V	С

Notes: 5. For a device mounted with the collector lead on 50mm x 50mm 2oz copper that is on a single-sided 1.6mm FR4 PCB; device is measured under still air conditions whilst operating in a steady-state.

6. Same as Note 5, except the device is mounted on 25mm x 25mm 2oz copper.

7. Same as Note 5, except the device is mounted on 25mm x 25mm 1oz copper.

8. Same as Note 5, except the device is mounted on minimum recommended pad layout.

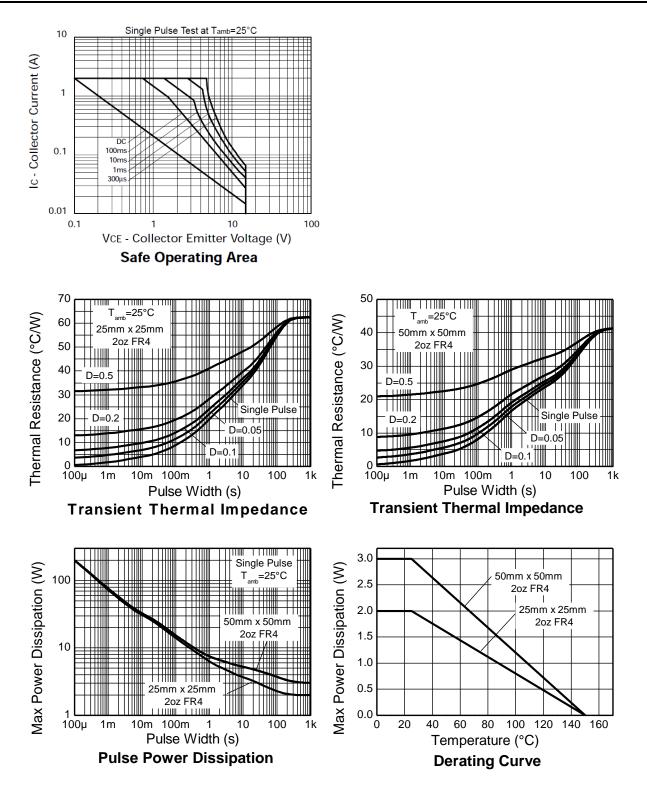
9. Thermal resistance from junction to solder-point (at the end of the collector lead).

10. Refer to JEDEC specification JESD22-A114 and JESD22-A115.





Thermal Characteristics and Derating Information







Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

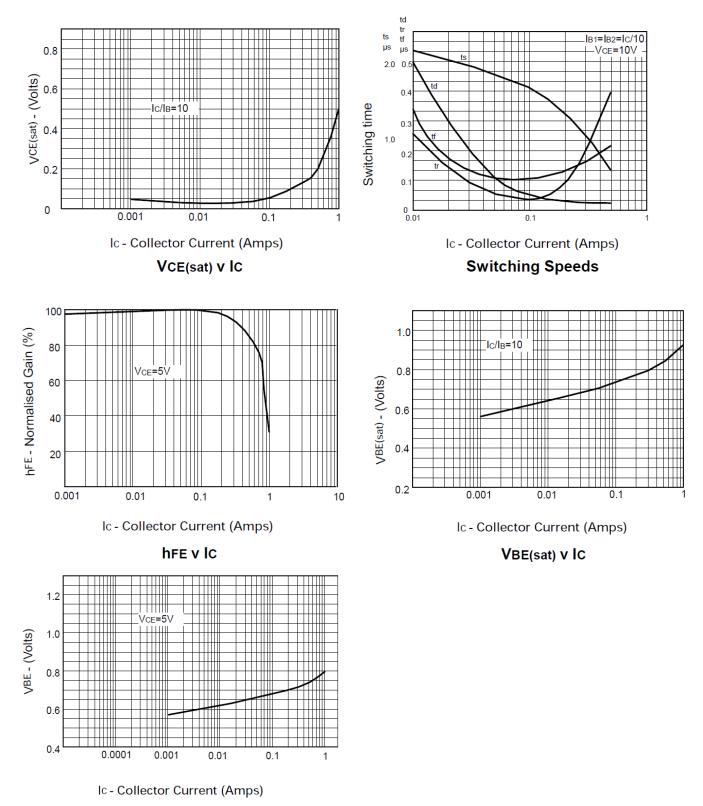
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	BV _{CBO}	-150	-	-	V	I _C = -100μA
Collector-Emitter Breakdown Voltage (Note 11)	BV _{CEO}	-150	-	-	V	I _C = -10mA
Emitter-Base Breakdown Voltage	BV _{EBO}	-7	_	_	V	I _E = -100μA
Collector Cut-Off Current	I _{CBO}	-	<1	-100	nA	V _{CB} = -125V
Emitter Cut-Off Current	I _{EBO}	-	<1	-100	nA	V _{EB} = -3V
Collector-Emitter Saturation Voltage (Note 11)	V		-	-0.5	V	$I_{C} = -500 \text{mA}, I_{B} = -50 \text{mA}$
	V _{CE(sat)}	-		-0.5		$I_{\rm C} = -1$ A, $I_{\rm B} = -200$ mA
Base-Emitter Saturation Voltage (Note 11)	V _{BE(sat)}	-	-	-1.1	V	$I_{C} = -500 \text{mA}, I_{B} = -50 \text{mA}$
Base-Emitter Turn-On Voltage (Note 11)	V _{BE(on)}	-	-	-1.0	V	I _C = -500mA, V _{CE} = -5V
		50		-		$I_{C} = -10 \text{mA}, V_{CE} = -5 \text{V}$
DC Current Gain (Note 11)	h _{FE}	50	-	300	_	$I_{C} = -500 \text{mA}, V_{CE} = -5 \text{V}$
		20		_		$I_{C} = -1A, V_{CE} = -5V$
Current Gain-Bandwidth Product	fT	30	_	-	MHz	$I_{C} = -10 \text{mA}, V_{CE} = -20 \text{V},$ f = 20MHz
Output Capacitance	Cobo	-	_	20	pF	V _{CB} = -10V, f = 1MHz

Note: 11. Measured under pulsed conditions. Pulse width ≤ 300 $\mu s.$ Duty cycle ≤ 2%.





Typical Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)



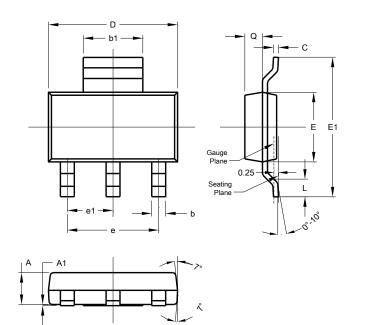
VBE(on) v IC





Package Outline Dimensions

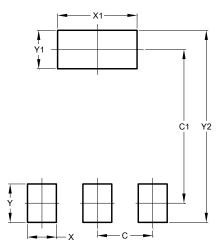
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



SOT223							
Dim	Dim Min Max Typ						
Α	1.55	1.65	1.60				
A1	0.010	0.15	0.05				
b	0.60	0.80	0.70				
b1	2.90	3.10	3.00				
С	0.20	0.30	0.25				
D	6.45	6.55	6.50				
E	3.45	3.55	3.50				
E1	6.90	7.10	7.00				
е	-	-	4.60				
e1	-	-	2.30				
L	0.85	1.05	0.95				
Q	0.84	0.94	0.89				
All [All Dimensions in mm						

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
С	2.30
C1	6.40
Х	1.20
X1	3.30
Y	1.60
Y1	1.60
Y2	8.00

Note: For high voltage applications, the appropriate industry sector guidelines should be considered with regards to creepage and clearance distances between device terminals and PCB tracking.





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